



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Yutaka WADA et al.

Serial No. 09/916,305 ✓

Filed July 30, 2001

POLISHING METHOD USING
AN ABRADING PLATE

: Confirmation No. 9053

: Docket No. 2001_1079

: Group Art Unit 3723

: Examiner Shantese L. McDonald

#12/C
+ sub. spec.
(12)

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AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

THE COMMISSIONER IS AUTHORIZED
TO CHARGE ANY DEFICIENCY IN THE
FEES FOR THIS PAPER TO DEPOSIT
ACCOUNT NO. 23-0975

Sir:

In response to the Office Action of April 23, 2003, the period for response to which having been extended by one month to August 23, 2003, please amend the above-identified U.S. Patent application as follows:

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AUG 28 2003
TC 3700 MAIL ROOM